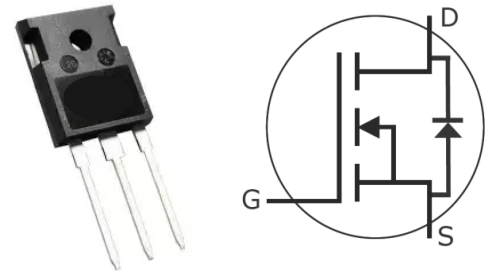


V_{DS}	=	1700 V
$R_{DS(on)}$	=	45 m Ω
$I_D@25^{\circ}C$	=	72 A



TO-247-3

Features

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitance
- Easy to Parallel and Simple to Drive

Benefits

- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

Applications

- Solar Inverters
- High Voltage DC/DC Converters
- Motor Drives
- Switch Mode Power Supplies
- Pulsed Power applications

Maximum Ratings ($T_c=25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
V_{DSmax}	Drain-Source Voltage	1700	V	$V_{GS}=0V, I_D=100\mu A$	
V_{GSmax}	Gate-Source Voltage	-10/+25	V	Absolute maximum values	
V_{GSop}	Gate-Source Voltage	-5/+20	V	Recommended operational values	
I_D	Continuous Drain Current	72	A	$V_{GS}=20V, T_c=25^{\circ}C$	
		48		$V_{GS}=20V, T_c=100^{\circ}C$	
$I_{D(pulse)}$	Pulsed Drain Current	160	A	Pulse width t_p limited by T_{Jmax}	
P_D	Power Dissipation	520	W	$T_c=25^{\circ}C, T_J=150^{\circ}C$	
T_J, T_{STG}	Operating Junction and Storage Temperature	-55 to +150	$^{\circ}C$		

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	1700	/	/	V	$V_{GS}=0V, I_D=100\mu A$	
$V_{GS(th)}$	Gate Threshold Voltage	2.0	2.6	4.0	V	$V_{DS}=V_{GS}, I_D=18mA$	Fig. 11
		/	1.8	/		$V_{DS}=V_{GS}, I_D=18mA, T_J=150^\circ\text{C}$	
I_{DSS}	Zero Gate Voltage Drain Current	/	1	100	μA	$V_{DS}=1700V, V_{GS}=0V$	
I_{GSS+}	Gate-Source Leakage Current	/	10	250	nA	$V_{DS}=0V, V_{GS}=25V$	
I_{GSS-}	Gate-Source Leakage Current	/	10	250	nA	$V_{DS}=0V, V_{GS}=-10V$	
$R_{DS(on)}$	Drain-Source On-State Resistance	/	45	70	m Ω	$V_{GS}=20V, I_D=50A$	
		/	90	/		$V_{GS}=20V, I_D=50A, T_J=150^\circ\text{C}$	
g_{fs}	Transconductance	/	25.8	/	S	$V_{DS}=20V, I_D=50A$	Fig. 4,5,6
		/	27.0	/		$V_{DS}=20V, I_D=50A, T_J=150^\circ\text{C}$	
C_{iss}	Input Capacitance	/	3550	/	pF	$V_{GS}=0V$	Fig. 15,16
C_{oss}	Output Capacitance	/	165	/		$V_{DS}=1000V$	
C_{rss}	Reverse Transfer Capacitance	/	6.1	/		$f=1MHz$	
E_{oss}	C_{oss} Stored Energy	/	101	/	μJ	$V_{AC}=25mV$	
E_{ON}	Turn-On Switching Energy	/	3.1	/	mJ	$V_{DS}=1200V, V_{GS}=-5V/20V$	
E_{OFF}	Turn-Off Switching Energy	/	1.1	/		$I_D=30A, R_{G(ext)}=2.5\Omega, L=100\mu H$	
$t_{d(on)}$	Turn-On Delay Time	/	27	/	ns	$V_{DS}=1200V, V_{GS}=-5V/20V, I_D=30A$ $R_{G(ext)}=2.5\Omega, R_L=20\Omega$	
t_r	Rise Time	/	32	/			
$t_{d(off)}$	Turn-Off Delay Time	/	36	/			
t_f	Fall Time	/	10	/			
$R_{G(int)}$	Internal Gate Resistance	/	2.6	/	Ω	$f=1MHz, V_{AC}=25mV$	
Q_{GS}	Gate to Source Charge	/	54	/	nC	$V_{DS}=1200V$	
Q_{GD}	Gate to Drain Charge	/	25	/		$V_{GS}=-5V/20V$	
Q_G	Total Gate Charge	/	193	/		$I_D=50A$	

Reverse Diode Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_{SD}	Diode Forward Voltage	4.5	/	V	$V_{GS}=-5V, I_{SD}=25A$	Fig. 8,9,10
		4.2	/		$V_{GS}=-5V, I_{SD}=25A, T_J=150^\circ\text{C}$	
I_S	Continuous Diode Forward Current	/	72	A	$T_c=25^\circ\text{C}$	
t_{rr}	Reverse Recover Time	55	/	ns	$V_R=1200V, I_{SD}=50A$	
Q_{rr}	Reverse Recovery Charge	220	/	nC		
I_{rrm}	Peak Reverse Recovery Current	6.7	/	A		

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
$R_{\theta JC}$	Thermal Resistance from Junction to Case	0.24	/	$^\circ\text{C/W}$		
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	/	40			

Typical Performance

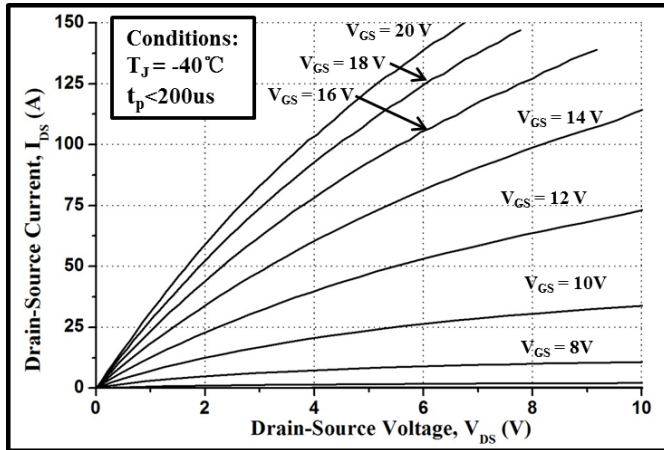


Figure 1. Output Characteristics $T_J = -40\text{ }^\circ\text{C}$

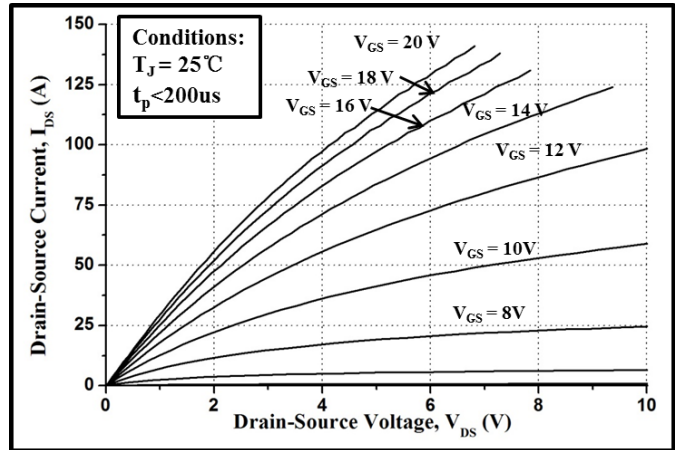


Figure 2. Output Characteristics $T_J = 25\text{ }^\circ\text{C}$

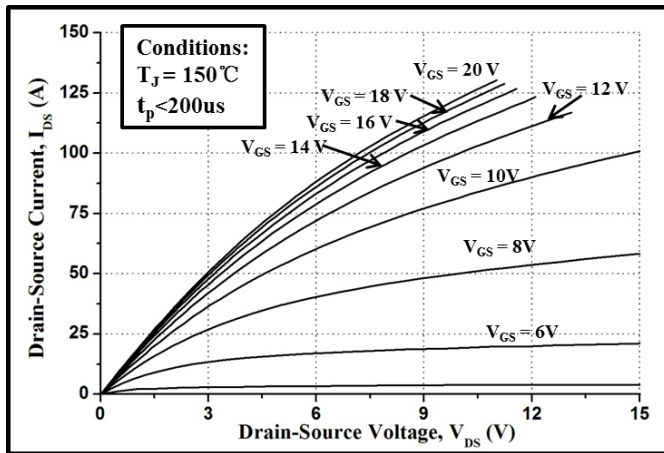


Figure 3. Output Characteristics $T_J = 150\text{ }^\circ\text{C}$

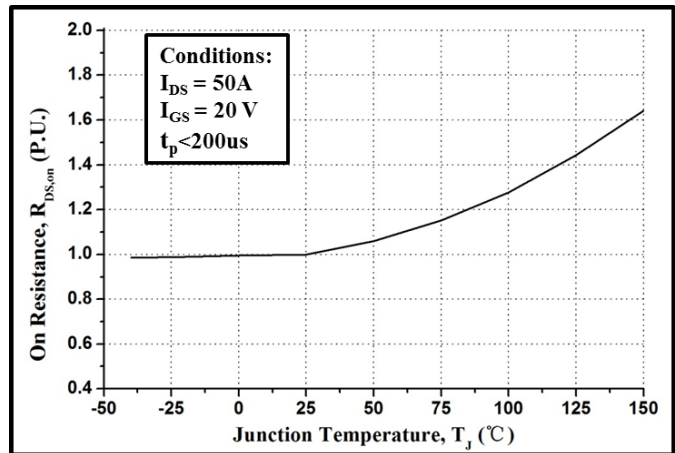


Figure 4. Normalized On-Resistance vs. Temperature

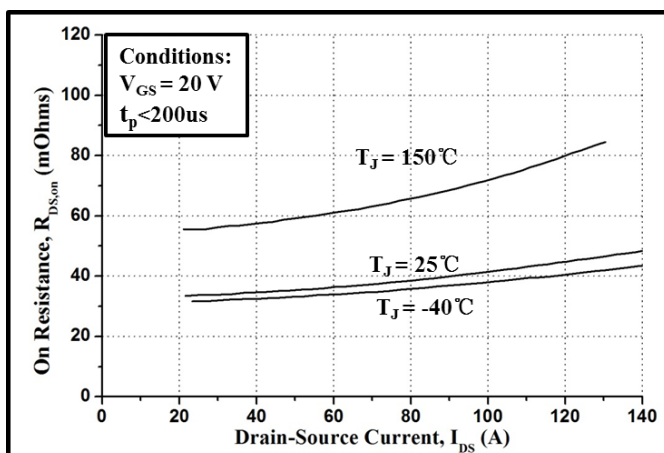


Figure 5. On-Resistance vs. Drain Current
For Various Temperatures

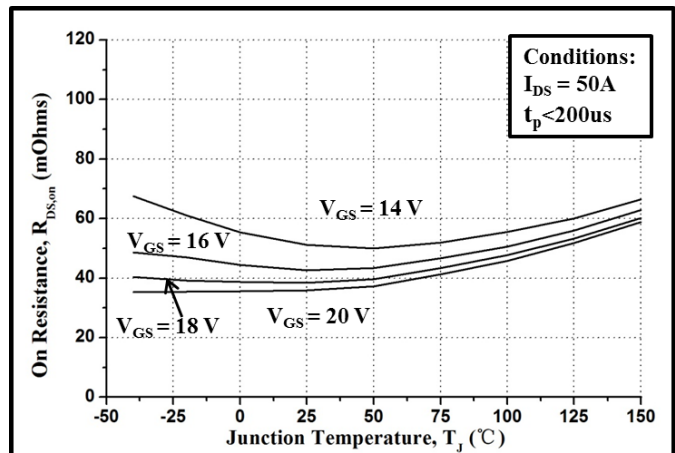


Figure 6. On-Resistance vs. Temperature
For Various Gate Voltage

Typical Performance

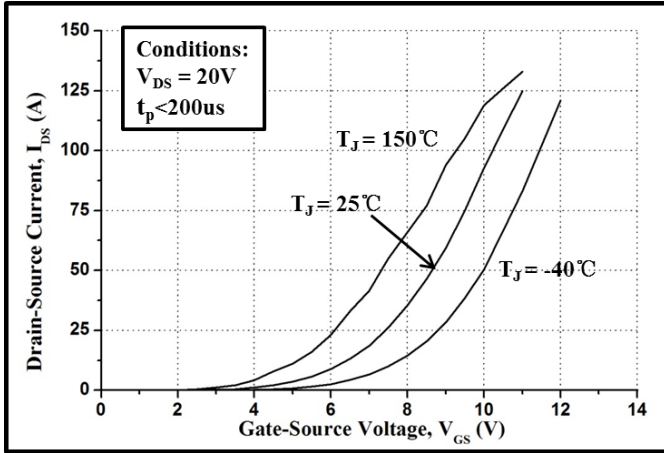


Figure 7. Transfer Characteristic for Various Junction Temperatures

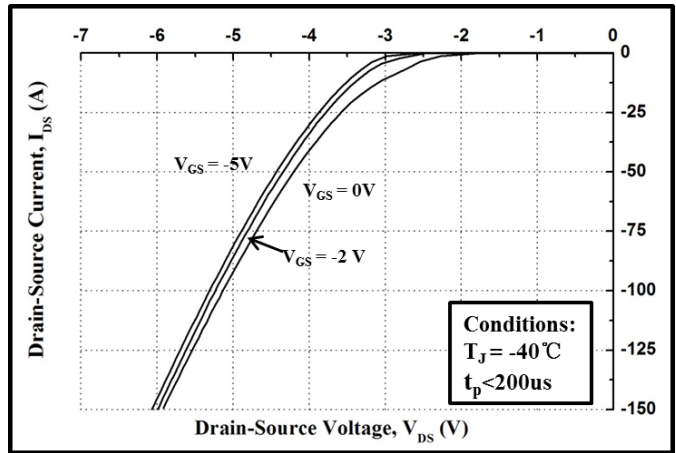


Figure 8. Body Diode Characteristic at -40 °C

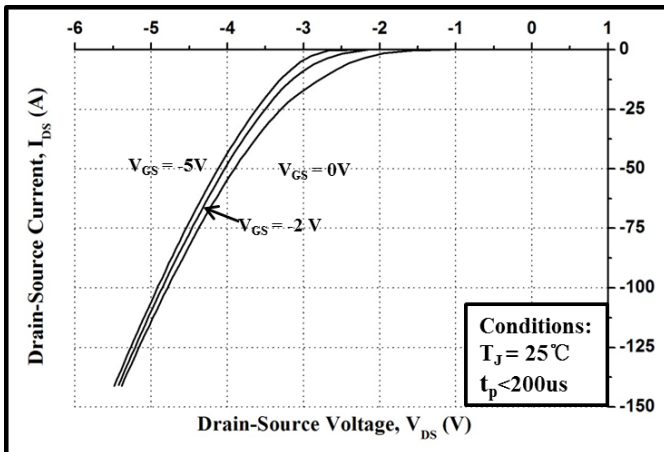


Figure 9. Body Diode Characteristic at 25 °C

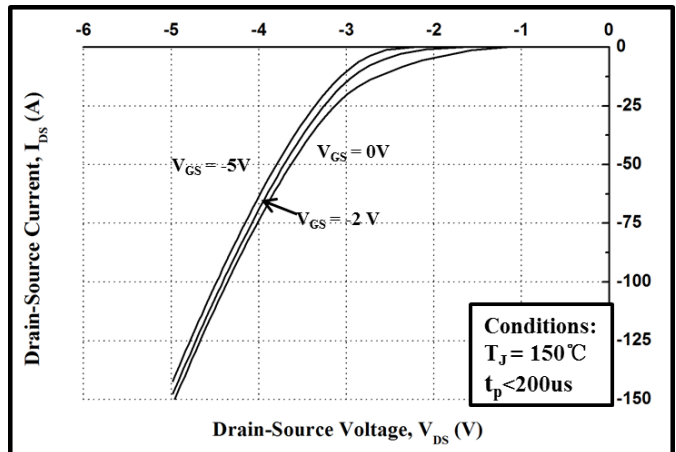


Figure 10. Body Diode Characteristic at 150 °C

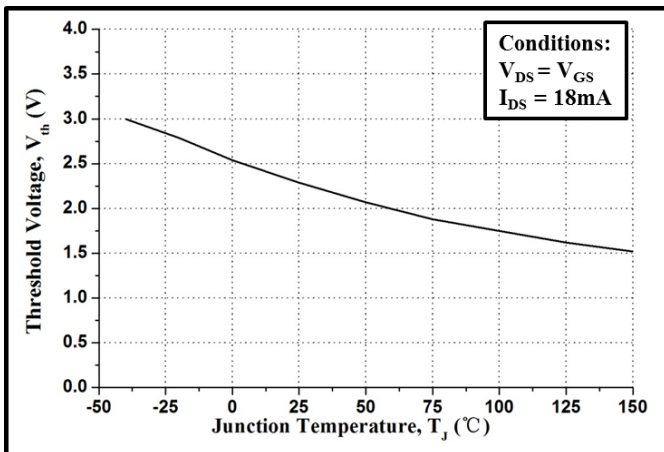


Figure 11. Threshold Voltage vs. Temperature

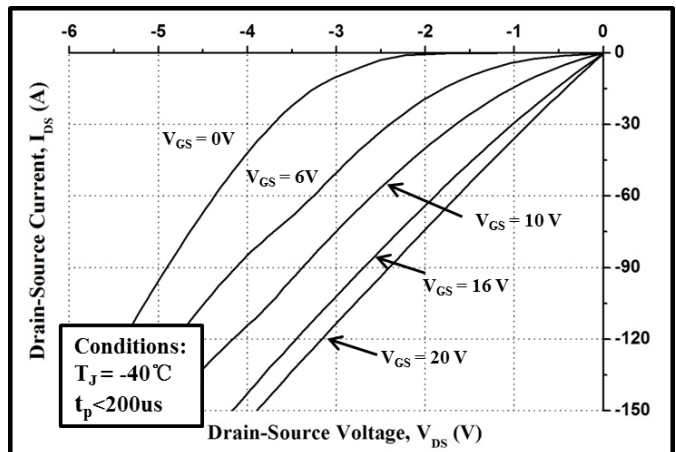


Figure 12. 3rd Quadrant Characteristic at -40 °C

Typical Performance

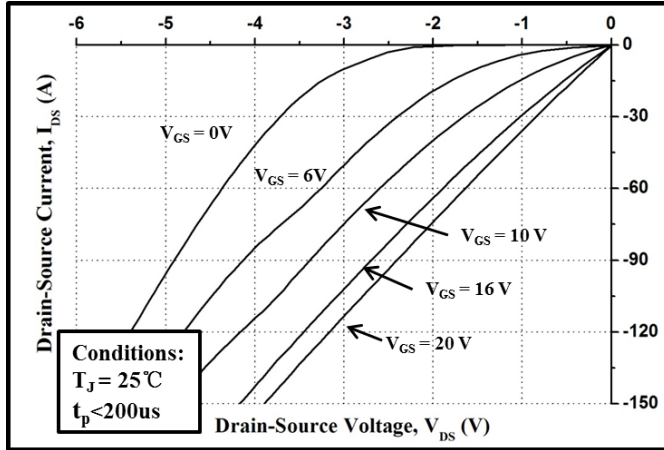


Figure 13. 3rd Quadrant Characteristic at 25 °C

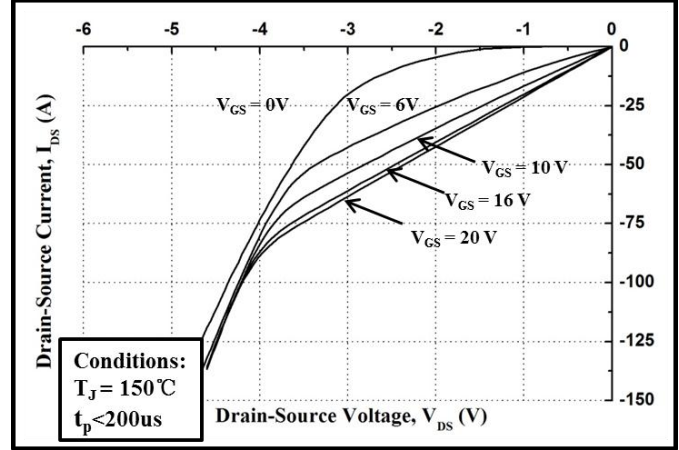


Figure 14. 3rd Quadrant Characteristic at 150 °C

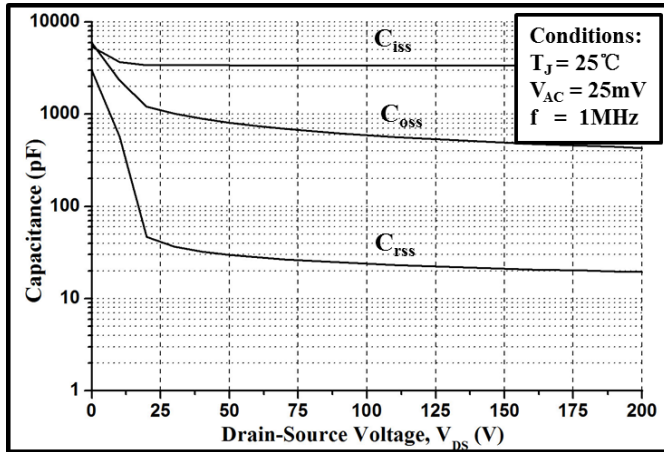


Figure 15. Capacitances vs. Drain-Source Voltage (0 - 200V)

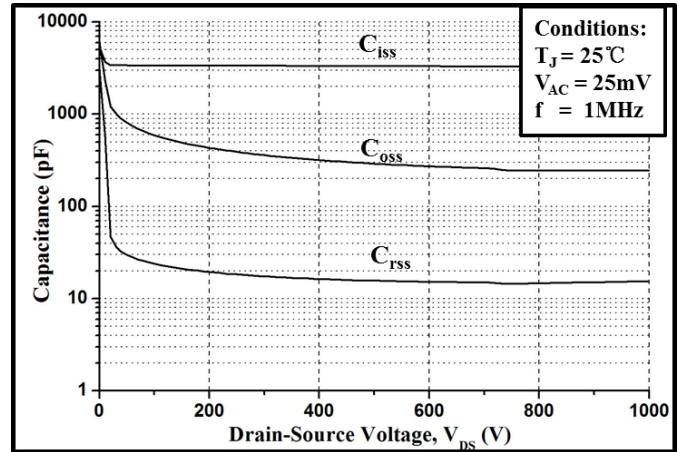


Figure 16. Capacitances vs. Drain-Source Voltage (0 - 1000V)

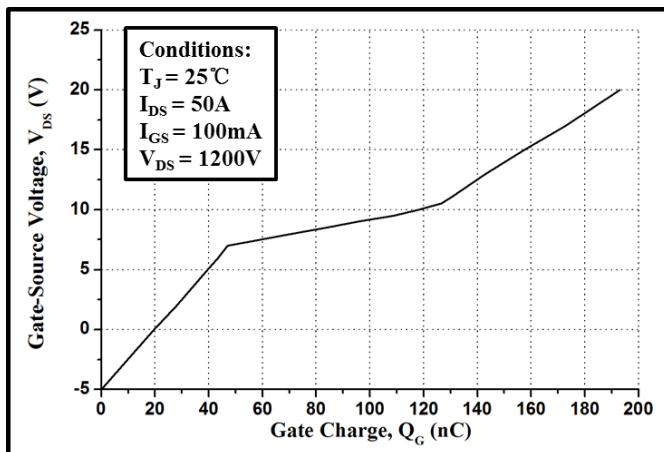


Figure 17. Gate Charge Characteristic

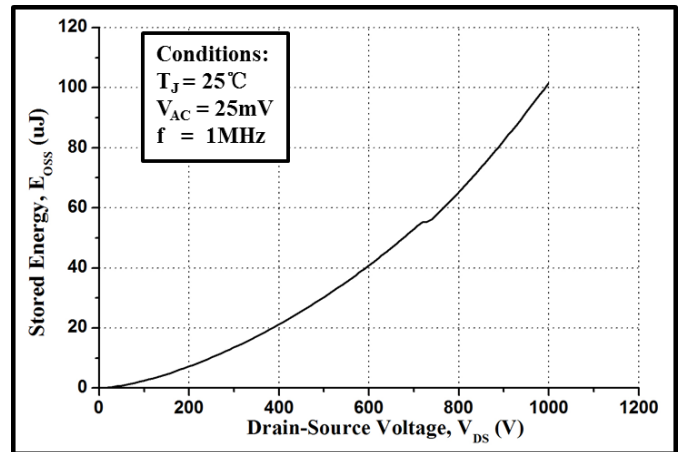
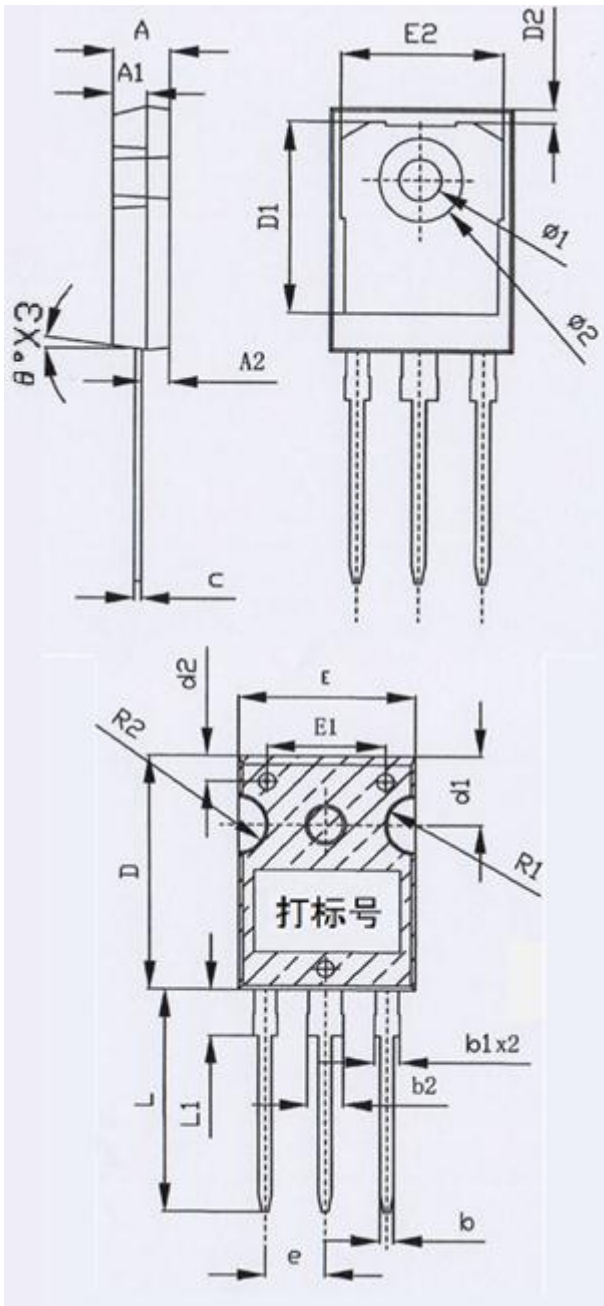


Figure 18. Output Capacitor Stored Energy

Package TO-247-3



SYMBOLS	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	4.9	5	5.1
A1	2.9	3	3.1
A2	2.31	2.36	2.41
b	1.16	1.2	1.26
b1	2.05	-	2.2
b2	3.05	-	3.2
c	0.58	0.6	0.66
D	20.9	21	21.1
D1	16.46	16.56	16.76
D2		1.17	
d1	6.05	6.15	6.25
d2	2.2	2.3	2.4
E	15.7	15.8	15.9
E1		10.5	
E2		14.02	
e	-	1.27bcs	-
L	19.82	19.92	20.02
L1	1.88	1.98	2.08
θ	0°	7°	8°
R1	-	2.7	-
R2	-	2.5	-
$\Phi 1$		3.6	
$\Phi 2$	-	7.19	-